1	BARRY MOSTELLER
2	straight.
3	Do you agree that there would be
4	overpressure problems if you attempted to make a
5	contactless card with a non-weight compensated
6	lamination machine?
7	MR. GASPARO: Objection.
8	A. Repeat the question again.
9	Q. Sure. Sure.
10	Would you agree that there would be
11	overpressure problems if you tried to manufacture
12	contactless cards with a non-weight compensated
13	lamination machine?
14	A. In some
15	MR. GASPARO: Objection.
16	A. In some instances.
17	Q. And one of the things that you would
18	encounter is that you would damage the chip
19	during the process, correct?
20	MR. GASPARO: Objection.
21	A. Not necessarily.
22	Q. Overpressure would not cause any
23	damage to the chip in the lamination process of a
24	contactless card?
25	MR. GASPARO: Objection.

1

2

3

5

6

8

9

10

11

12

13

14

15

16

17

1.8

. 19

20

21

22

23

24

25

Q.

BARRY MOSTELLER Α. In my opinion, it depends on specific circumstances other than just the fact that you do or don't have zero compensation. Q. Did you -- before you obtained this weight compensated lamination machine this year, did you run into the problem of chips being damaged during the lamination process of contactless cards? MR. GASPARO: Objection. I've seen chips damaged in both a standard laminator and a zero compensation lamination process. 0. Would you characterize the number of chips you've seen damaged in the compensator or in the zero weight compensator? MR. GASPARO: Objection. Q. On a percentage basis. In a specific -- in a specific instance, with a specific construction, with a specific module, I have witnessed a 1 to 2 percent higher scrap on a non-zero compensation laminator. By the same token, I have witnessed without having a significant difference.

Would you agree that you would